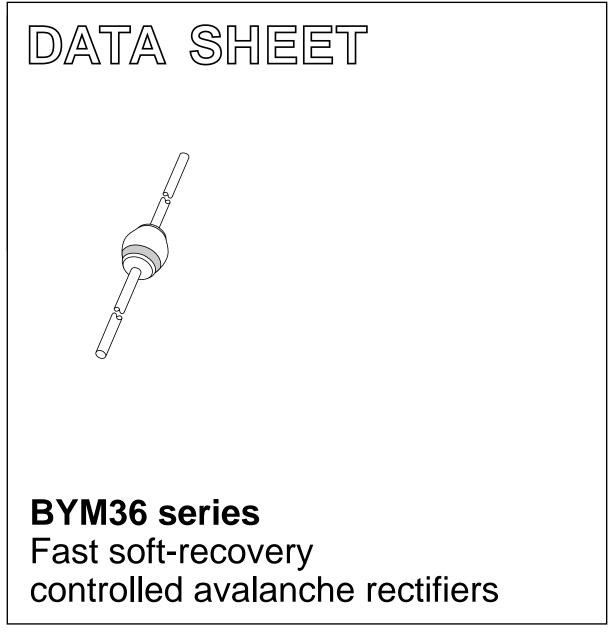
## DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1996 May 30



#### **Product specification**

**BYM36** series

## Fast soft-recovery controlled avalanche rectifiers

### FEATURES

- Glass passivated
- High maximum operating temperature
- Low leakage current
- · Excellent stability
- Guaranteed avalanche energy absorption capability
- Available in ammo-pack
- Also available with preformed leads for easy insertion.

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	repetitive peak reverse voltage				
	ВҮМ36А		-	200	V
	ВҮМ36В		-	400	V
	BYM36C		-	600	V
	BYM36D		_	800	V
	BYM36E		_	1000	V
	BYM36F		_	1200	V
	BYM36G		_	1400	V
V <sub>R</sub>	continuous reverse voltage				
	ВҮМ36А		-	200	V
	ВҮМ36В		_	400	V
	BYM36C		_	600	V
	BYM36D		_	800	V
	BYM36E		_	1000	V
	BYM36F		_	1200	V
	BYM36G		_	1400	V
I <sub>F(AV)</sub>	average forward current	T <sub>tp</sub> = 55 °C; lead length = 10 mm;			
	BYM36A to C	see Figs 2; 3 and 4 averaged over any 20 ms period; see also Figs 14; 15 and 16	_	3.0	A
	BYM36D and E		_	2.9	A
	BYM36F and G		_	2.9	A
I <sub>F(AV)</sub>	average forward current	T <sub>amb</sub> = 65 °C; PCB mounting (see			
	BYM36A to C	Fig.25); see Figs 5; 6 and 7 averaged over any 20 ms period; see also Figs 14; 15 and 16	_	1.25	A
	BYM36D and E		_	1.20	A
	BYM36F and G		_	1.15	A

#### DESCRIPTION

Rugged glass SOD64 package, using a high temperature alloyed construction. This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

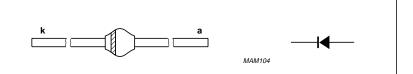


Fig.1 Simplified outline (SOD64) and symbol.

## BYM36 series

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>FRM</sub>	repetitive peak forward current	$T_{tp}$ = 55 °C; see Figs 8; 9 and 10			
	BYM36A to C		-	37	A
	BYM36D and E		_	33	A
	BYM36F and G		-	27	A
I <sub>FRM</sub>	repetitive peak forward current	T <sub>amb</sub> = 65 °C; see Figs 11; 12 and 13			
	BYM36A to C		-	13	A
	BYM36D and E		-	11	A
	BYM36F and G		-	10	A
I <sub>FSM</sub>	non-repetitive peak forward current	t = 10 ms half sine wave; $T_j = T_{j max}$ prior to surge; $V_R = V_{RRMmax}$	-	65	A
E <sub>RSM</sub>	non-repetitive peak reverse avalanche energy	L = 120 mH; $T_j = T_{j max}$ prior to surge; inductive load switched off	-	10	mJ
T <sub>stg</sub>	storage temperature		-65	+175	°C
Tj	junction temperature	see Figs 17 and 18	-65	+175	°C

### ELECTRICAL CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	forward voltage	$I_{F} = 3 \text{ A}; T_{j} = T_{j \text{ max}};$				
	BYM36A to C	see Figs 19; 20 and 21	-	_	1.22	V
	BYM36D and E		-	_	1.28	V
	BYM36F and G		-	-	1.24	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A;				
	BYM36A to C	see Figs 19; 20 and 21	-	-	1.60	V
	BYM36D and E		-	-	1.78	V
	BYM36F and G		-	-	1.57	V
V <sub>(BR)R</sub>	reverse avalanche breakdown	I <sub>R</sub> = 0.1 mA				
	voltage					
	BYM36A		300	-	-	V
	BYM36B		500	-	-	V
	BYM36C		700	-	-	V
	BYM36D		900	-	-	V
	BYM36E		1100	-	-	V
	BYM36F		1 300	-	-	V
	BYM36G		1500	-	-	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = V <sub>RRMmax</sub> ; see Fig.22	-	-	5	μA
		V <sub>R</sub> = V <sub>RRMmax</sub> ; T <sub>j</sub> = 165 °C; see Fig.22	-	_	150	μA

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t <sub>rr</sub>	reverse recovery time	when switched from				
	BYM36A to C	$I_{\rm F} = 0.5 \text{ A to } I_{\rm R} = 1 \text{ A};$	-	_	100	ns
	BYM36D and E	measured at I <sub>R</sub> = 0.25 A; see Fig. 26	-	_	150	ns
	BYM36F and G	See 1 lg. 20	-	-	250	ns
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V;				
	BYM36A to C	see Figs 23 and 24	-	85	-	pF
	BYM36D and E		-	75	-	pF
	BYM36F and G		-	65	-	pF
$\frac{dI_R}{dt}$	maximum slope of reverse recovery current	when switched from $I_F = 1 \text{ A to } V_R \ge 30 \text{ V and}$				
ut	BYM36A to C	$dI_F/dt = -1 A/\mu s;$	-	-	7	A/µs
	BYM36D and E	see Fig.27	_	_	6	A/μs
	BYM36F and G		-	_	5	A/μs

### THERMAL CHARACTERISTICS

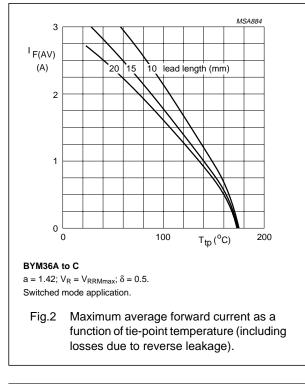
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-tp</sub>	thermal resistance from junction to tie-point	lead length = 10 mm	25	K/W
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	75	K/W

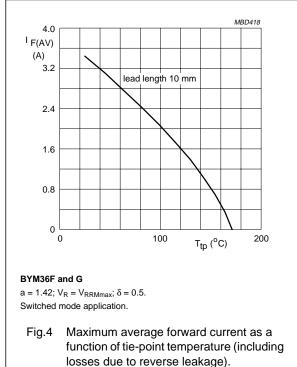
Note

1. Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer ≥40 μm, see Fig.25. For more information please refer to the *"General Part of associated Handbook"*.

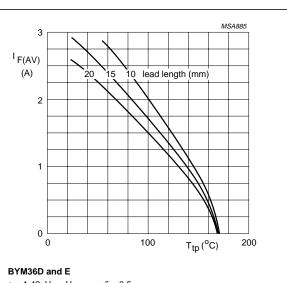
### BYM36 series

### **GRAPHICAL DATA**



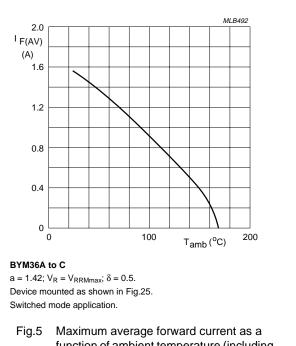






a = 1.42;  $V_R = V_{RRMmax}$ ;  $\delta = 0.5$ . Switched mode application.

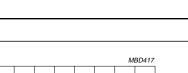
Fig.3 Maximum average forward current as a function of tie-point temperature (including losses due to reverse leakage).

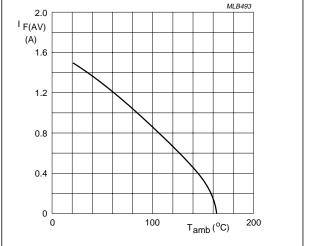


function of ambient temperature (including losses due to reverse leakage).

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## Fast soft-recovery controlled avalanche rectifiers

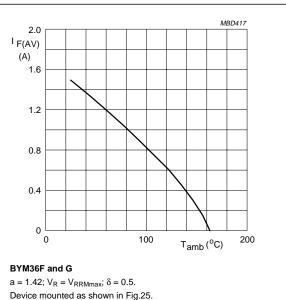




#### BYM36D and E

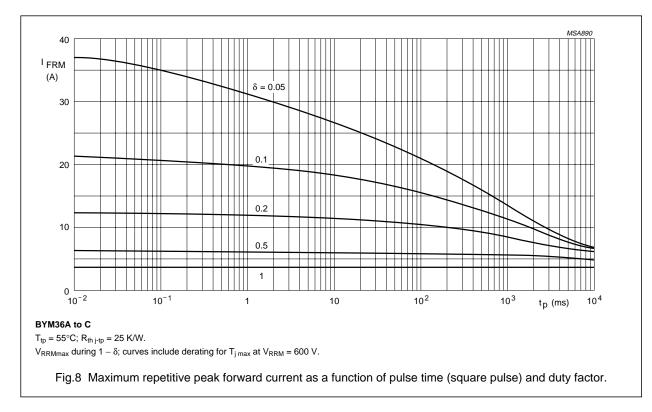
a = 1.42;  $V_R = V_{RRMmax}$ ;  $\delta = 0.5$ . Device mounted as shown in Fig.25. Switched mode application.

Maximum average forward current as a Fig.6 function of ambient temperature (including losses due to reverse leakage).

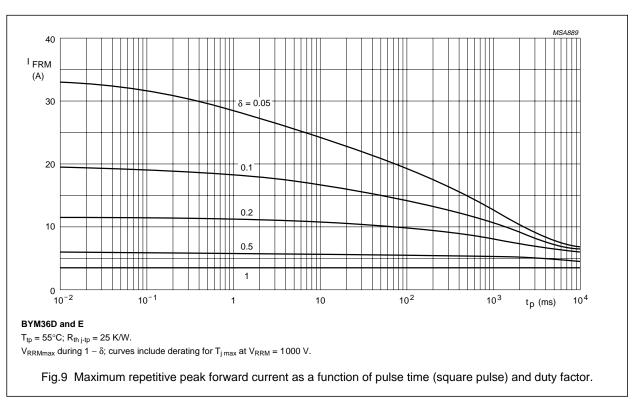


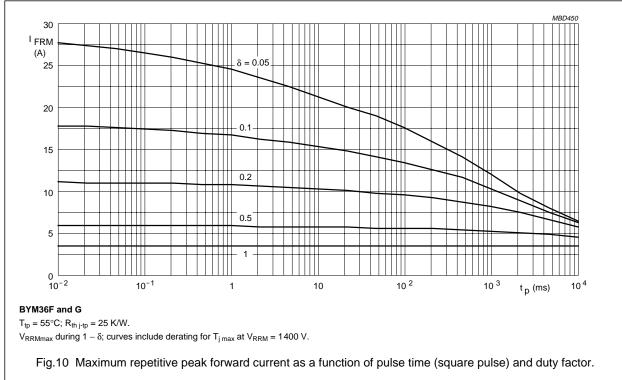
Switched mode application.

Maximum average forward current as a Fig.7 function of ambient temperature (including losses due to reverse leakage).

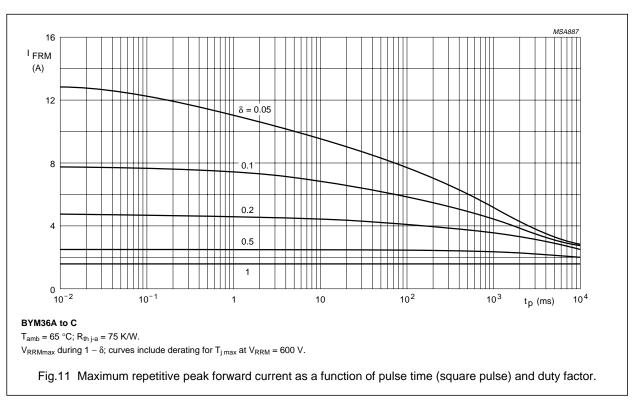


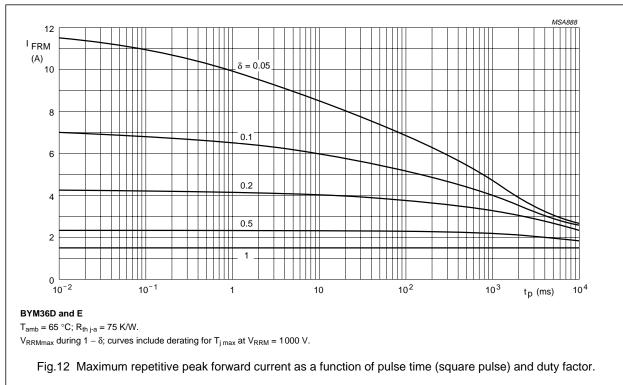
### BYM36 series



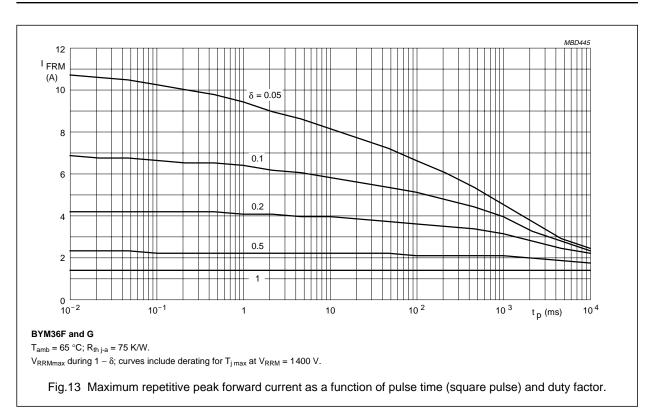


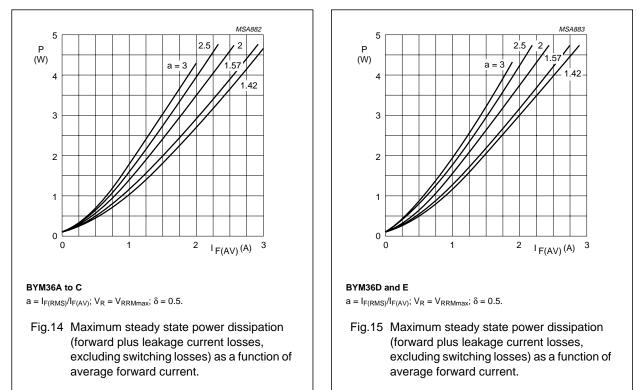
## BYM36 series



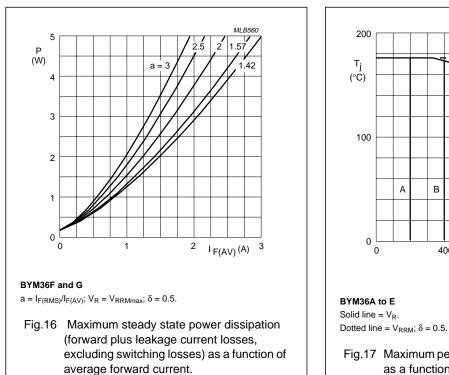


## BYM36 series





## BYM36 series



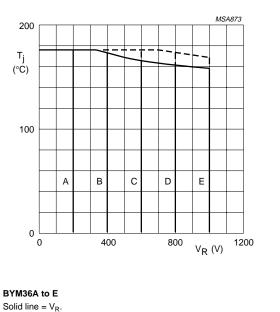
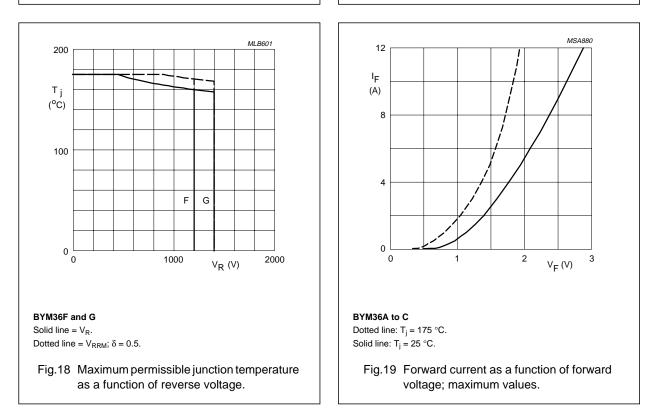
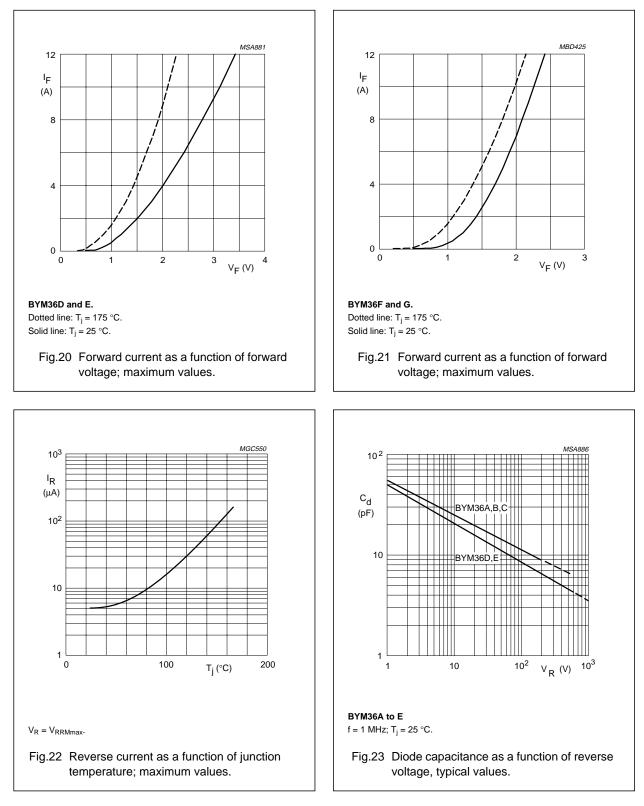


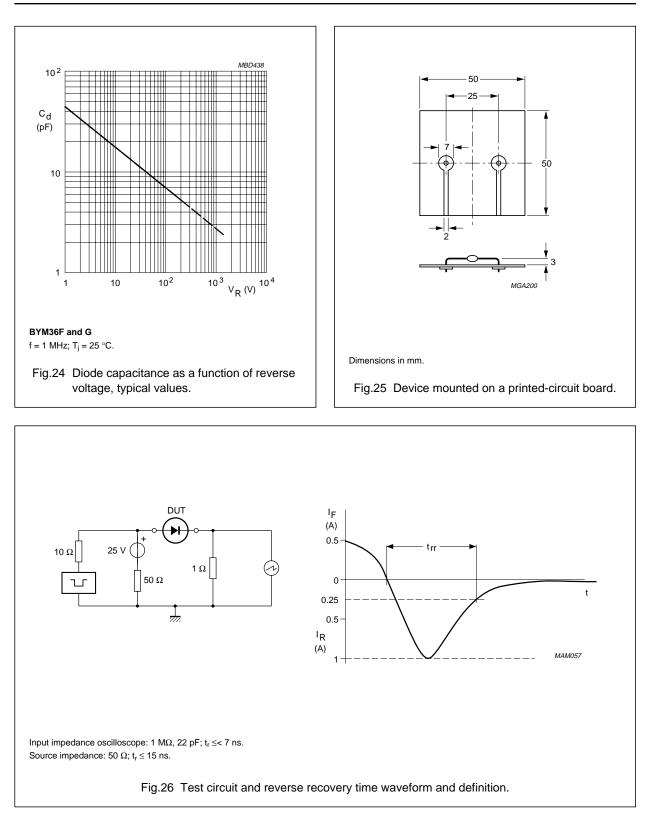
Fig.17 Maximum permissible junction temperature as a function of reverse voltage.



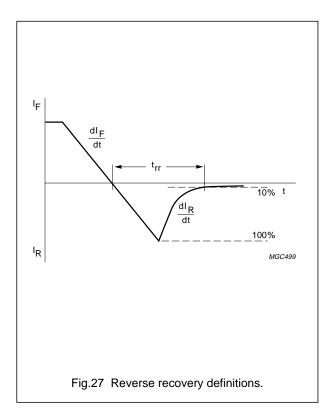
### BYM36 series



### BYM36 series

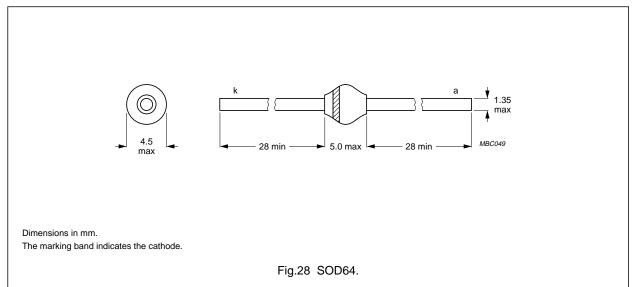


## BYM36 series



### **BYM36** series

### PACKAGE OUTLINE



#### DEFINITIONS

Data Sheet Status		
Objective specification	This data sheet contains target or goal specifications for product development.	
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.	
Product specification	This data sheet contains final product specifications.	
Limiting values		
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.		
Application information		

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.